

## KEY FEATURES

- SMPTE 259M and SMPTE 344M compliant
- dual coaxial cable driving outputs
- 50Ω differential PECL input
- single 3.3V power supply operation
- space-saving 8-lead SOIC
- operating temperature range: 0°C to 70°C
- pin compatible with GS1528 HD-LINX™ II multirate SDI dual slew-rate cable driver
- Pb-free and Green

## APPLICATIONS

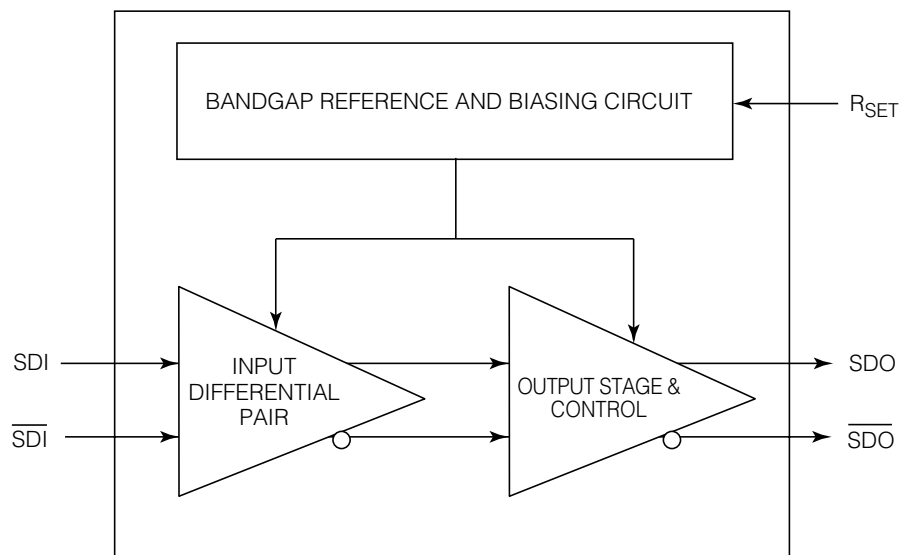
- SMPTE 259M Coaxial Cable Serial Digital Interfaces

## DESCRIPTION

The GS9068 is a second generation high-speed bipolar integrated circuit designed to drive one or two 75Ω co-axial cables at data rates up to 540Mb/s.

The GS9068 accepts a LVPECL level differential input, which may be AC coupled. External biasing resistors at the inputs are not required.

Power consumption is typically 160mW using a +3.3V DC power supply.



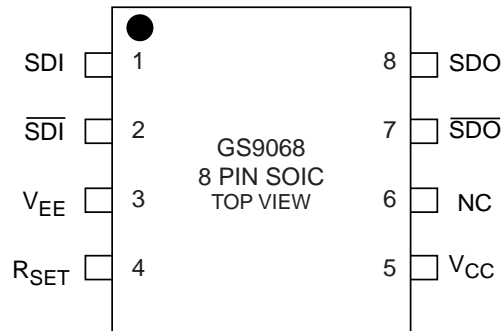
**GS9068 FUNCTIONAL BLOCK DIAGRAM**

**TABLE OF CONTENTS**

|  |     |
|--|-----|
| <b>1. PIN OUT</b> .....                            | 3   |
| <b>1.1 PIN ASSIGNMENT</b> .....                    | 3   |
| <b>1.2 PIN DESCRIPTIONS</b> .....                  | 3   |
| <b>2. ELECTRICAL CHARACTERISTICS</b> .....         | 4   |
| <b>2.1 ABSOLUTE MAXIMUM RATINGS</b> .....          | 4   |
| <b>2.2 DC ELECTRICAL CHARACTERISTICS</b> .....     | 4   |
| <b>2.3 AC ELECTRICAL CHARACTERISTICS</b> .....     | 4   |
| <b>3. DETAILED DESCRIPTION</b> .....               | 5-6 |
| <b>3.1 SERIAL DIGITAL INPUT</b> .....              | 5   |
| <b>3.2 SERIAL DIGITAL OUTPUT</b> .....             | 5   |
| <b>3.3 OUTPUT RETURN LOSS MEASUREMENT</b> .....    | 5   |
| <b>3.4 OUTPUT AMPLITUDE ADJUSTMENT</b> .....       | 6   |
| <b>4. APPLICATION REFERENCE DESIGN</b> .....       | 6   |
| <b>4.1 PCB LAYOUT</b> .....                        | 6   |
| <b>4.2 TYPICAL APPLICATION CIRCUIT</b> .....       | 6   |
| <b>5. REFERENCES</b> .....                         | 7   |
| <b>6. PACKAGE &amp; ORDERING INFORMATION</b> ..... | 7   |
| <b>6.1 PACKAGE DIMENSIONS</b> .....                | 7   |
| <b>6.2 ORDERING INFORMATION</b> .....              | 7   |
| <b>7. REVISION HISTORY</b> .....                   | 8   |

# 1. PIN OUT

## 1.1 PIN ASSIGNMENT



GS9068

## 1.2 PIN DESCRIPTIONS

| PIN NUMBER | NAME                         | TYPE        | DESCRIPTION   |
|------------|------------------------------|-------------|---|
| 1,2        | SDI, $\overline{\text{SDI}}$ | Input       | Serial digital differential input.                        |
| 3          | $V_{EE}$                     | Input Power | Most negative power supply connection - connect to GND.   |
| 4          | $R_{SET}$                    | Input       | External output amplitude control resistor.               |
| 5          | $V_{CC}$                     | Input Power | Most positive power supply connection - connect to +3.3V. |
| 6          | NC                           | -           | No Connect.   |
| 7,8        | SDO, $\overline{\text{SDO}}$ | Output      | Serial digital differential output.                       |

## 2. ELECTRICAL CHARACTERISTICS

### 2.1 ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$  unless otherwise indicated

| PARAMETER                            | VALUE   |
|--------------------------------------|---|
| Supply Voltage                       | -0.5V to 3.6 $V_{DC}$                         |
| Input ESD Voltage                    | 500V  |
| Storage Temperature Range            | $-50^\circ\text{C} < T_s < 125^\circ\text{C}$ |
| Input Voltage Range (any input)      | -0.3 to $(V_{CC} + 0.3)V$                     |
| Operating Temperature Range          | $0^\circ\text{C}$ to $70^\circ\text{C}$       |
| Power Dissipation                    | 300mW   |
| Lead Temperature (soldering, 10 sec) | $260^\circ\text{C}$                           |

#### CAUTION

The GS9068 is sensitive to electrostatic discharge. Use extreme caution, observing all ESD-prevention practices, during handling and assembly. The SDI inputs of the GS9068 must be protected from electrostatic discharge and electrical overstress during the handling and operation of circuit assemblies containing the device.

### 2.2 DC ELECTRICAL CHARACTERISTICS

$V_{CC} = 3.3V$ ,  $V_{EE} = 0V$ ,  $T_A = 0^\circ\text{C}$  to  $70^\circ\text{C}$ , 270Mb/s unless otherwise shown

| PARAMETER         | SYMBOL   | CONDITIONS  | MIN                            | TYPICAL                       | MAX                               | UNITS | TEST LEVEL |
|-------------------|----------|-------------|--------------------------------|-------------------------------|-----------------------------------|-------|------------|
| Supply Voltage    | $V_{CC}$ |             | 3.1                            | 3.3                           | 3.5                               | V     | 3          |
| Power Consumption | $P_D$    |             | -                              | 160                           | -                                 | mW    | 5          |
| Supply Current    | $I_s$    |             | -                              | 48                            | -                                 | mA    | 1          |
| Output Voltage    | $V_{OC}$ | Common mode | -                              | $V_{CC} - \Delta V_{SDO(SE)}$ | -                                 | mV    | 6          |
| Input Voltage     | $V_{IC}$ | Common mode | $1.6 + \Delta V_{SDI(DIFF)}/2$ | -                             | $V_{CC} - \Delta V_{SDI(DIFF)}/2$ | mV    | 1          |

### 2.3 AC ELECTRICAL CHARACTERISTICS

$V_{CC} = 3.3V$ ,  $V_{EE} = 0V$ ,  $T_A = 0^\circ\text{C}$  to  $70^\circ\text{C}$ , 270Mb/s unless otherwise shown

| PARAMETER                  | SYMBOL                   | CONDITIONS  | MIN | TYPICAL | MAX  | UNITS      | TEST LEVEL |
|----------------------------|--------------------------|---|-----|---------|------|------------|------------|
| Serial input data rate     | $DR_{SDI}$               |   | -   | -       | 540  | Mb/s       | 1          |
| Input Voltage Swing        | $\Delta V_{SDI(DIFF)}$   | Differential  | 300 | -       | 2000 | $mV_{p-p}$ | 1          |
| Output Voltage Swing       | $\Delta V_{SDO(SE)}$     | Single Ended into $75\Omega$ external load<br>$R_{SET} = 750\Omega$ | 750 | 800     | 850  | $mV_{p-p}$ | 1          |
| Additive jitter            |                          |   | -   | -       | 30   | ps         | 1          |
| Rise/Fall time             | $t_r, t_f$               | 20% - 80%   | 400 | -       | 800  | ps         | 1          |
| Mismatch in rise/fall time | $\Delta t_r, \Delta t_f$ |   | -   | -       | 30   | ps         | 1          |
| Duty cycle distortion      |                          |   | -   | -       | 100  | ps         | 1          |
| Overshoot                  |                          |   | -   | -       | 8    | %          | 1          |
| Output Return Loss         | ORL                      |   | 15  | -       | -    | dB         | 7          |

#### TEST LEVELS

1. Production test at room temperature and nominal supply voltage with guardbands for supply and temperature ranges.
2. Production test at room temperature and nominal supply voltage with guardbands for supply and temperature ranges using correlated test.
3. Production test at room temperature and nominal supply voltage.
4. QA sample test.
5. Calculated result based on Level 1, 2, or 3.
6. Not tested. Guaranteed by design simulations.
7. Not tested. Based on characterization of nominal parts.
8. Not tested. Based on existing design/characterization data of similar product.
9. Indirect test.
10. Wafer Probe

### 3. DETAILED DESCRIPTION

#### 3.1 SERIAL DIGITAL INPUT

SDI/ $\overline{\text{SDI}}$  are high impedance differential inputs. Several conditions must be observed when interfacing to these inputs:

1. The differential input signal amplitude must be between 300 and 2000mVpp.
2. For DC coupling to the device, the common mode voltage must be between  $1.6 + \Delta V_{\text{SDI(DIFF)}}$  and  $V_{\text{CC}} - \Delta V_{\text{SDI(DIFF)}}$ .
3. For input trace lengths longer than approximately 1cm, the inputs should be terminated as shown in the Typical Application Circuit.

The GS9068 inputs are self-biased, allowing for simple AC coupling to the device. For serial digital video, a minimum capacitor value of  $4.7\mu\text{F}$  should be used to allow coupling of pathological test signals. A tantalum capacitor is recommended.

#### 3.2 SERIAL DIGITAL OUTPUT

The GS9068 outputs are current mode and will drive 800mV into a  $75\Omega$  load. These outputs are protected from accidental static damage with internal static protection diodes.

The SMPTE 259M standard requires that the output of a cable driver have a source impedance of  $75\Omega$  and a return loss of at least 15dB between 5MHz and 540MHz. In order for an SDI output circuit using the GS9068 to meet this specification, the output circuit shown in the Typical Application Circuit is recommended.

The value of  $L_{\text{COMP}}$  will vary depending on the PCB layout, with a typical value of  $5.6\text{nH}$ . A  $4.7\mu\text{F}$  capacitor is used for AC coupling the output of the GS9068. This value is chosen to ensure that pathological signals can be coupled without a significant DC component occurring.

See Section 4, *Application Reference Design*, for more details.

When measuring return loss at the GS9068 output, it is necessary to take the measurement for both a logic high and a logic low output condition. This is because the output protection diodes act as a varactor (voltage controlled capacitor) as shown in Figure 1. Consequently, the output capacitance of the GS9068 is dependent on the logic state of the output.

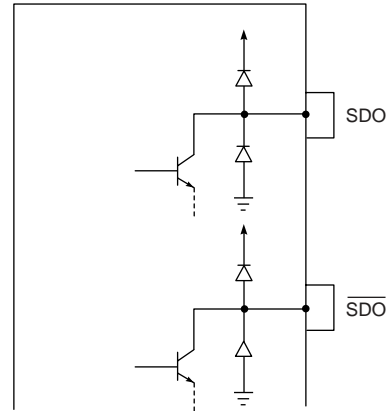


Fig. 1 Static Protection Diodes

#### 3.3 OUTPUT RETURN LOSS MEASUREMENT

To perform a practical return loss measurement, it is necessary to force the GS9068 output to a DC high or low condition. The actual return loss will be based on the outputs being static at  $V_{\text{CC}}$  or  $V_{\text{CC}} - 1.6\text{V}$ . Under normal operating conditions the outputs of the GS9068 swing between  $V_{\text{CC}} - 0.4\text{V}$  and  $V_{\text{CC}} - 1.2\text{V}$ , so the measured value of return loss will not represent the actual operating return loss.

A simple method of calculating the values of actual operating return loss is to interpolate the two return loss measurements. In this way, the values of return loss are estimated at  $V_{\text{CC}} - 0.4\text{V}$  and  $V_{\text{CC}} - 1.2\text{V}$  based on the measurements at  $V_{\text{CC}}$  and  $V_{\text{CC}} - 1.6\text{V}$ .

The two values of return loss (high and low) will typically differ by several decibels. If the measured return loss is  $R_{\text{H}}$  for logic high and  $R_{\text{L}}$  for logic low, then the two values can be interpolated as follows:

$$R_{\text{IH}} = R_{\text{H}} - (R_{\text{H}} - R_{\text{L}})/4, \text{ and}$$

$$R_{\text{IL}} = R_{\text{L}} + (R_{\text{H}} - R_{\text{L}})/4,$$

where  $R_{\text{IH}}$  is the interpolated logic high value and  $R_{\text{IL}}$  is the interpolated logic low value.

For example, if  $R_{\text{H}} = -18\text{dB}$  and  $R_{\text{L}} = -14\text{dB}$ , then the interpolated values are  $R_{\text{IH}} = -17\text{dB}$  and  $R_{\text{IL}} = -15\text{dB}$ .

### 3.4 OUTPUT AMPLITUDE ADJUSTMENT

The output amplitude of the GS9068 can be adjusted by changing the value of the  $R_{SET}$  resistor as shown in Figure 2 and Table 1 below. For an 800mV<sub>p-p</sub> output with a nominal  $\pm 7\%$  tolerance, a value of 750 $\Omega$  is required. A  $\pm 1\%$  SMT resistor should be used.

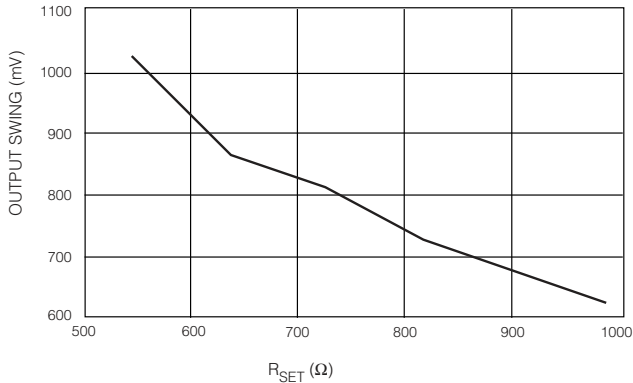


Fig. 2 Output Amplitude Adjustment

The  $R_{SET}$  resistor is part of the high speed output circuit of the GS9068. The resistor should be placed as close as possible to the  $R_{SET}$  pin. In addition, the PCB capacitance should be minimized at this node by removing the PCB groundplane beneath the  $R_{SET}$  resistor and the  $R_{SET}$  pin.

Table 1:  $R_{SET}$  vs  $V_{OD}$

| $R_{SET}$ ( $\Omega$ ) | OUTPUT SWING |
|------------------------|--------------|
| 995                    | 608mV        |
| 824                    | 734mV        |
| 750                    | 800mV        |
| 600                    | 884mV        |
| 573                    | 1040mV       |

NOTE: For reliable operation of the GS9068 over the full temperature range, do not use an  $R_{SET}$  value below 573 $\Omega$ .

## 4. APPLICATION REFERENCE DESIGN

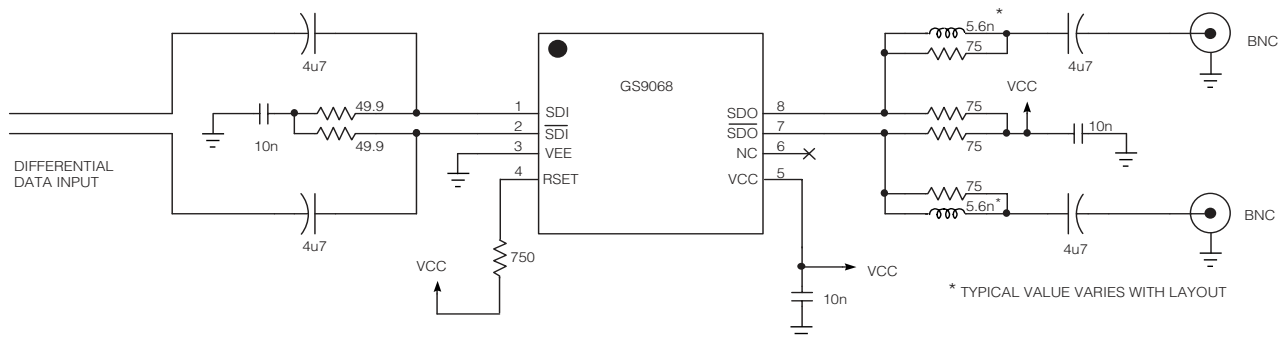
### 4.1 PCB LAYOUT

An FR-4 dielectric can be used, however, controlled impedance transmission lines are required for PCB traces longer than approximately 1cm. Note the following PCB artwork features used to optimize performance:

- The PCB groundplane is removed under the GS9068 output components to minimize parasitic capacitance.

- The PCB ground plane is removed under the GS9068  $R_{SET}$  pin and resistor to minimize parasitic capacitance.
- Input and output BNC connectors are surface mounted in-line to eliminate a transmission line stub caused by a BNC mounting via high speed traces which are curved to minimize impedance variations due to change of PCB trace width.

### 4.2 TYPICAL APPLICATION CIRCUIT



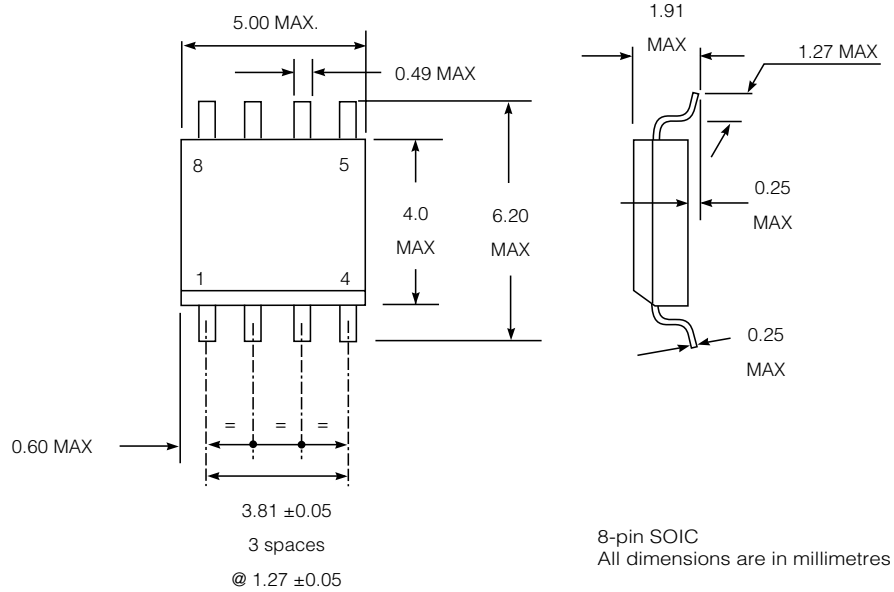
NOTE: All resistors in Ohms, capacitors in Farads, and inductors in Henrys, unless otherwise noted.

## 5. REFERENCES

Compliant with SMPTE 259M and SMPTE 344M.

## 6. PACKAGE & ORDERING INFORMATION

### 6.1 PACKAGE DIMENSIONS



### 6.2 ORDERING INFORMATION

| PART NUMBER  | PACKAGE         | TEMPERATURE RANGE | Pb-FREE AND GREEN |
|--------------|-----------------|-------------------|-------------------|
| GS9068-CKA   | 8 pin SOIC      | 0°C to 70°C       | No                |
| GS9068-CTA   | 8 pin SOIC Tape | 0°C to 70°C       | No                |
| GS9068-CKAE3 | 8 pin SOIC      | 0°C to 70°C       | Yes               |
| GS9068-CTAE3 | 8 pin SOIC Tape | 0°C to 70°C       | Yes               |

## 7. REVISION HISTORY

| VERSION | ECR    | DATE          | CHANGES AND/OR MODIFICATIONS   |
|---------|--------|---------------|--|
| A       | 120608 | July 2002     | New Document   |
| B       | 125775 | July 2002     | Added detailed block descriptions and initial applications information.  |
| 0       | 127024 | December 2002 | Document upgraded to Preliminary Data Sheet and AC/DC Characteristics edited to match current design specification limits. |
| 1       | 128544 | March 2003    | Document upgraded to Data Sheet.   |
| 2       | 133977 | June 2004     | Added lead-free and green information.   |

### DOCUMENT IDENTIFICATION

#### DATA SHEET

The product is in production. Gennum reserves the right to make changes at any time to improve reliability, function or design, in order to provide the best product possible.

### CAUTION

ELECTROSTATIC  
SENSITIVE DEVICES

DO NOT OPEN PACKAGES OR HANDLE  
EXCEPT AT A STATIC-FREE WORKSTATION



### GENNUM CORPORATION

MAILING ADDRESS:  
P.O. Box 489, Stn. A, Burlington, Ontario, Canada L7R 3Y3  
Tel. +1 (905) 632-2996 Fax. +1 (905) 632-5946

SHIPPING ADDRESS:  
970 Fraser Drive, Burlington, Ontario, Canada L7L 5P5

GENNUM JAPAN CORPORATION  
Shinjuku Green Tower Building 27F, 6-14-1, Nishi Shinjuku,  
Shinjuku-ku, Tokyo, 160-0023 Japan  
Tel. +81 (03) 3349-5501, Fax. +81 (03) 3349-5505

GENNUM UK LIMITED  
25 Long Garden Walk, Farnham, Surrey, England GU9 7HX  
Tel. +44 (0)1252 747 000 Fax +44 (0)1252 726 523

Gennum Corporation assumes no responsibility for the use of any circuits described herein and makes no representations that they are free from patent infringement.

© Copyright July 2002 Gennum Corporation. All rights reserved. Printed in Canada.